

Title (en)

PLASTICALLY DEFORMABLE COOLING BODY FOR ELECTRIC AND/OR ELECTRONIC COMPONENTS

Title (de)

PLASTISCH VERFORMBARER KÜHLKÖRPER FÜR ELEKTRISCHE UND/ODER ELEKTRONISCHE BAUELEMENTE

Title (fr)

CORPS DE REFROIDISSEMENT A DEFORMATION PLASTIQUE DESTINE A DES COMPOSANTS ELECTRIQUES ET/OU ELECTRONIQUES

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Application

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Abstract (en)

[origin: WO2005034236A1] The invention relates to a cooling body for electric and/or electronic components, in particular printed circuit boards. The cooling body consists of a chemically uniform material, whose exterior is cross-linked and which is thus poorly or non-adhesive and whose interior can be plastically deformed and thus adapted to the contours of the components or printed circuit boards. The cooling body can be cured by thermal post-cross-linking.

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